

**IEEE UEMCON 2019** 

CONFERENCE SPONSORS TEE

The 10th IEEE Annual Ubiquitous Computing, Electronics & Mobile Communication Confe Venue: Columbia University, New York, USA



HOME CALL FOR PAPERS VENUE & TRAVEL GALLERY KEYNOTE SPEAKERS SUBMISSIONS PROGRAM COMMITTEE REGISTRATION CONTACT



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## **Welcome to IEEE UEMCON 2019**

Continuing from the outstanding success of IEEE UEMCON 2018, we are proud to present IEEE UEMCON 2019 which will provide an opportunity for researchers, educators and students to discuss and exchange ideas on issues, trends, and developments in Information Technology, Electronics and Mobile Communication. The conference aims to bring together scholars from different disciplinary backgrounds to emphasize dissemination of ongoing research in the fields of in Information Technology, Electronics and Mobile Communication. Contributed papers are solicited describing original works in the above-mentioned fields and related technologies. The conference will include a peer-reviewed program of technical sessions, special sessions, business application sessions, tutorials, and demonstration sessions.

Accepted papers will be presented during the parallel sessions of the Conference. All accepted and presented papers will be submitted for publication in the IEEE Xplore Digital Library and searchable in Scopus, DBLP, Ei Compendex, Web of Science and Google Scholar. IEEE UEMCON 2019 is listed in IEEE conference listing HERE.

Special session conducted on the below-mentioned topic: i.On Low Power Wireless Sensor Networks and Mobile Ad-hoc Networks.Kindly check PDF for

ii.On Blockchain Applications in Smart Systems. Kindly check PDF for more details. iii.On Machine Learning for Cybersecurity.Kindly check PDF for more details.

This conference will also promote an intense dialogue between academia and industry to bridge the gap between academic research, industry initiatives, and governmental policies. This is fostered through panel discussions, keynotes, invited talks and industry exhibits where academia is exposed to state-of-practice and results from trials and interoperability experiments. The industry in turn benefits by exposure to leading-edge research in networking as well as the opportunity to communicate with academic researchers regarding practical problems that require further research.

One of the world's great cities, New York City (known as "The Big Apple", "NYC," or just "New York") is a global center for media, entertainment, art, fashion, research, finance, and trade. The bustling, cosmopolitan heart of the 4th largest metropolis in the world and by far the most populous city in the United States, New York has long been a key entry point and a defining city for the nation. From the Statue of Liberty in the harbor to the Empire State Building towering over the Manhattan skyline, from the tunnels of the subway to the skyscrapers of Wall Street, from the bright signs of Times Square to the naturalistic beauty of Central Park, and from Yankee Stadium in the Bronx to Coney Island in Brooklyn, New York's landmarks are quintessential American landmarks. Please see the beauty of New York here.

Keynote Speakers at our previous conferences



## **IEEE UEMCON 2017**

## Announcements Conference Proceedings will be submitted for publication at **IEEE Xplore Digital Library**

 Conference Record No 47517 ·Best Paper Award will be given for each track There will be two workshops

on- i. Data Analysis and ii. IoT Workshop - Concepts to Implementation on 12th October 2019 ·There will be first ever Smart

Maker Festival- Global Innovación in New York to be held at Columbia University on 12th October, 2019. Kindly check the WEBPAGE and a SMART POWER TALKS is there.Check the flyer HERE.

Time: 9 a.m. to 5 p.m. Venue: Faculty House, 64 Morningside Dr, Columbia University, New York, NY 10027, USA Conference Organising committee also invites proposals for Workshop/Tutorials on different fields.

·Conference Organising Committee invites proposals for 'Call for demonstrations'. Visit the call for papers tab for details.